





DMN4036LK3

#### **40V N-CHANNEL ENHANCEMENT MODE MOSFET**

### **Product Summary**

| V <sub>(BR)DSS</sub> | R <sub>DS(on)</sub>           | I <sub>D</sub><br>T <sub>A</sub> = 25°C |  |  |
|----------------------|-------------------------------|---|--|--|
| 401/                 | 36mΩ @ V <sub>GS</sub> = 10V  | 12.2A                                   |  |  |
| 40V                  | 61mΩ @ V <sub>GS</sub> = 4.5V | 9.4A                                    |  |  |

## **Description and Applications**

This new generation MOSFET has been designed to minimize the onstate resistance ( $R_{DS(on)}$ ) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Backlighting
- DC-DC Converters
- Power management functions

#### **Features and Benefits**

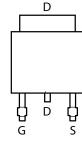
- Low on-resistance
- Fast switching speed
- "Green" component and RoHS compliant (Note 1)

## **Mechanical Data**

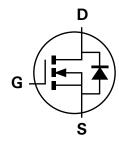
- Case: TO252-3L
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0 (Note 1)
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals Connections: See Diagram
- Terminals: Matte Tin Finish annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Marking Information: See Below
- Ordering Information: See Below
- Weight: 0.33 grams (approximate)



TOP VIEW



PIN OUT -TOP VIEW



Equivalent Circuit

#### Ordering Information (Note 1)

| Product       | Marking | Reel size (inches) | Tape width (mm) | Quantity per reel |  |
|---------------|---------|--------------------|-----------------|-------------------|--|
| DMN4036LK3-13 | N4036L  | 13                 | 16              | 2,500             |  |

Note: 1. Diodes, Inc. defines "Green" products as those which are Eu RoHS compliant and contain no halogens or antimony compounds; further information about Diodes Inc.'s "Green" Policy can be found on our website. For packaging details, go to our website.

## **Marking Information**







## Maximum Ratings @T<sub>A</sub> = 25°C unless otherwise specified

| Cha   | racteristic    |                               | Symbol Value     |      | Unit |  |
|---|----------------|-------------------------------|------------------|------|------|--|
| Drain-Source voltage                                |                |                               | V <sub>DSS</sub> | 40   | V    |  |
| Gate-Source voltage                                 |                |                               | V <sub>GS</sub>  | ±20  | V    |  |
|   |                | (Note 3)                      | ID               | 12.2 |      |  |
| Continuous Drain current                            | $V_{GS} = 10V$ | T <sub>A</sub> =70°C (Note 3) |                  | 9.7  | А    |  |
|   |                | (Note 2)                      |                  | 8.5  |      |  |
| Pulsed Drain current V <sub>GS</sub> = 10V (Note 4) |                | IDM                           | 31.7             | А    |      |  |
| Continuous Source current (Body diode) (Note 3)     |                | Is                            | 10.4             | А    |      |  |
| Pulsed Source current (Body diode) (Note 4)         |                | Ism                           | 31.7             | А    |      |  |

#### Thermal Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

| Characteristic                              | Symbol                           | Value               | Unit                 |              |  |
|---|----------------------------------|---------------------|----------------------|--------------|--|
|   | (Note 2)                         |                     | 4.12<br>33           | − W<br>mW/°C |  |
| Power dissipation<br>Linear derating factor | (Note 3)                         | PD                  | 8.49<br>67.9         |              |  |
| , , , , , , , , , , , , , , , , , , ,       | (Note 5)                         |                     | 2.12<br>16.9         |              |  |
| Thermal Resistance, Junction to Ambient     | (Note 2)<br>(Note 3)<br>(Note 5) | R <sub>0JA</sub>    | 30.3<br>14.7<br>59.0 | °C/W         |  |
| Thermal Resistance, Junction to Lead        | (Note 6)                         | $R_{	ext{	heta}JL}$ | 3.1                  |              |  |
| Operating and storage temperature range     |                                  | TJ, TSTG            | -55 to 150           | °C           |  |

2. For a device surface mounted on 50mm x 50mm x 1.6mm FR4 PCB with high coverage of single sided 2oz copper, in still air conditions; the device is Notes: measured when operating in a steady-state condition.

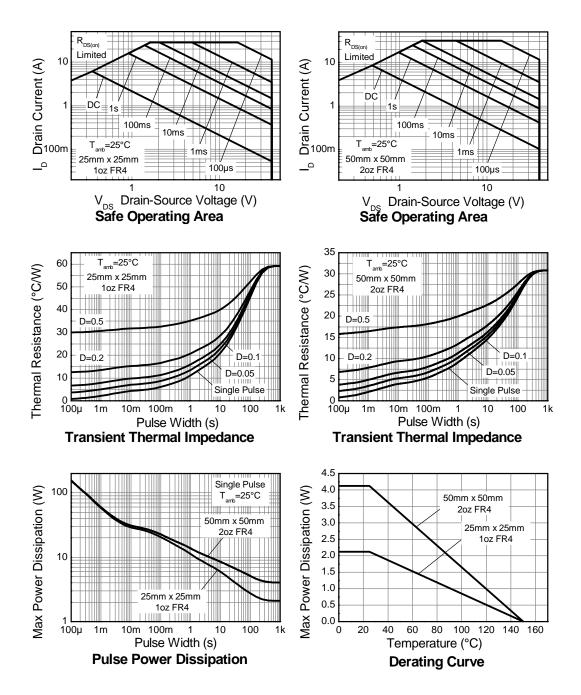
3. Same as note 2, except the device is pulsed with D = 0.02 and pulse width 300 µs. The pulse current is limited by the maximum junction temperature.

5. For a device surface mounted on 25mm x 25mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition.

6. Thermal resistance from junction to solder-point (at the end of the drain lead).



## **Thermal Characteristics**







# Electrical Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

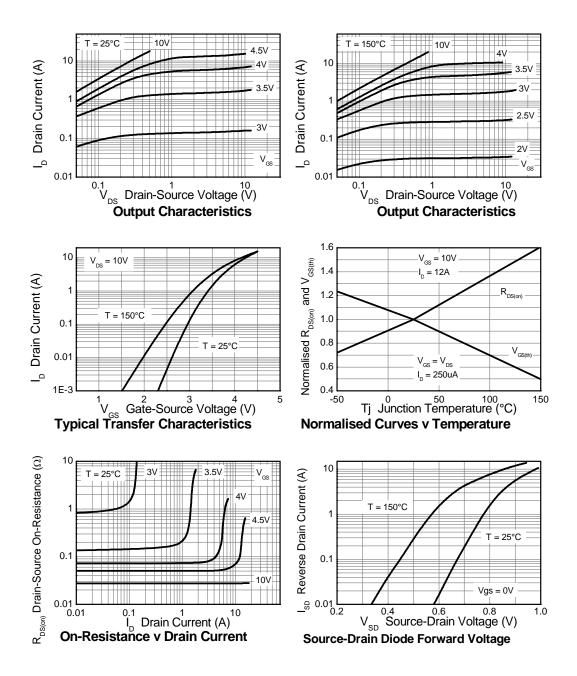
| Characteristic                             | Symbol               | Min | Тур  | Max   | Unit | Test Condition   |                       |  |
|--|----------------------|-----|------|-------|------|--|-----------------------|--|
| OFF CHARACTERISTICS                        |                      |     |      |       |      |  |                       |  |
| Drain-Source Breakdown Voltage             | BV <sub>DSS</sub>    | 40  |      | _     | V    | I <sub>D</sub> = 250μA, V <sub>GS</sub> = 0V             |                       |  |
| Zero Gate Voltage Drain Current            | I <sub>DSS</sub>     |     |      | 0.5   | μA   | $V_{DS}$ = 40V, $V_{GS}$                                 | = 0V                  |  |
| Gate-Source Leakage                        | I <sub>GSS</sub>     |     |      | ±100  | nA   | V <sub>GS</sub> = ±20V, V <sub>DS</sub> = 0V             |                       |  |
| ON CHARACTERISTICS                         |                      |     |      |       |      |  |                       |  |
| Gate Threshold Voltage                     | V <sub>GS(th)</sub>  | 1.0 |      | 3.0   | V    | $I_D=250\mu A, V_Ds$                                     | s= V <sub>GS</sub>    |  |
| Static Drain-Source On-Resistance (Note 7) | Pro (out)            |     |      | 0.036 | Ω    | $V_{GS}$ = 10V, $I_{D}$ =                                | 12A                   |  |
|  | R <sub>DS (ON)</sub> | _   |      | 0.061 | 52   | $V_{GS}$ = 4.5V, $I_{D}$ =                               | 6A                    |  |
| Forward Transconductance (Notes 7 & 8)     | <b>g</b> fs          |     | 19.6 | _     | S    | V <sub>DS</sub> = 15V, I <sub>D</sub> = 12A              |                       |  |
| Diode Forward Voltage (Note 7)             | V <sub>SD</sub>      |     | 0.96 | 1.1   | V    | I <sub>S</sub> = 12A, V <sub>GS</sub> = 0V               |                       |  |
| Reverse recovery time (Note 8)             | t <sub>rr</sub>      |     | 112  | _     | ns   | —I <sub>S</sub> = 12A, di/dt= 100A/μs                    |                       |  |
| Reverse recovery charge (Note 8)           | Q <sub>rr</sub>      |     | 926  | _     | nC   |  |                       |  |
| DYNAMIC CHARACTERISTICS (Note 8)           |                      |     |      |       |      |  |                       |  |
| Input Capacitance                          | C <sub>iss</sub>     |     | 453  | _     | pF   |  |                       |  |
| Output Capacitance                         | C <sub>oss</sub>     |     | 79.1 | _     | pF   | V <sub>DS</sub> = 20V, V <sub>GS</sub> = 0V<br>– f= 1MHz |                       |  |
| Reverse Transfer Capacitance               | C <sub>rss</sub>     |     | 40.5 | _     | pF   | 1- 111112  |                       |  |
| Total Gate Charge                          | Qg                   |     | 4.9  | _     | nC   | V <sub>GS</sub> = 4.5V                                   |                       |  |
| Total Gate Charge                          | Qg                   |     | 9.2  | _     | nC   |  | V <sub>DS</sub> = 20V |  |
| Gate-Source Charge                         | Q <sub>gs</sub>      | _   | 1.7  | _     | nC   | V <sub>GS</sub> = 10V                                    | I <sub>D</sub> = 12A  |  |
| Gate-Drain Charge                          | Q <sub>gd</sub>      | _   | 2.7  | _     | nC   |  |                       |  |
| Turn-On Delay Time (Note 9)                | t <sub>D(on)</sub>   |     | 3.2  |       | ns   |  |                       |  |
| Turn-On Rise Time (Note 9)                 | tr                   | _   | 11.7 |       | ns   | V <sub>DD</sub> = 20V, V <sub>GS</sub> = 10V             |                       |  |
| Turn-Off Delay Time (Note 9)               | t <sub>D(off)</sub>  | _   | 11.6 | _     | ns   | I <sub>D</sub> = 12A, R <sub>G</sub> ≅ 6.0Ω              |                       |  |
| Turn-Off Fall Time (Note 9)                | t <sub>f</sub>       |     | 9.5  | _     | ns   | $\neg$   |                       |  |

Notes:

Measured under pulsed conditions. Pulse width ≤ 300µs; duty cycle ≤ 2%
For design aid only, not subject to production testing.
Switching characteristics are independent of operating junction temperatures.

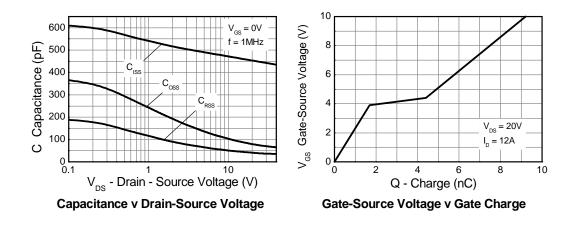


# **Typical Characteristics**

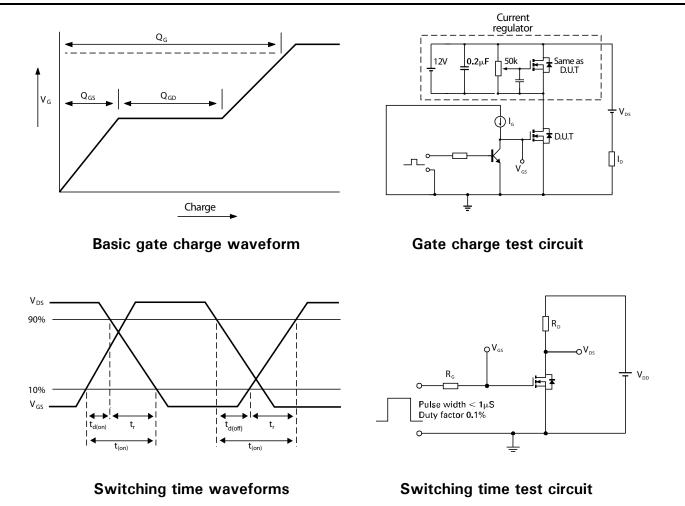




# **Typical Characteristics - continued**

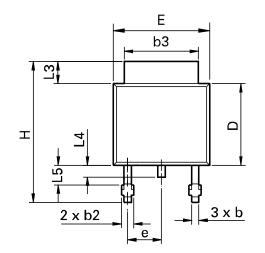


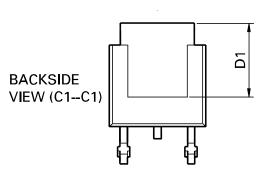
**Test Circuits** 

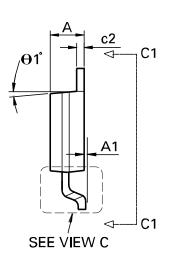


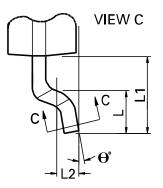


# **Package Outline Dimensions**





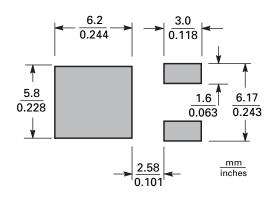




| DIM | Inc   | Inches |       | Millimeters |     | Inches    |       | Millimeters |       |
|-----|-------|--------|-------|-------------|-----|-----------|-------|-------------|-------|
|     | Min   | Max    | Min   | Max         |     | Min       | Max   | Min         | Max   |
| А   | 0.086 | 0.094  | 2.18  | 2.39        | е   | 0.090 BSC |       | 2.29 BSC    |       |
| A1  | -     | 0.005  | -     | 0.127       | н   | 0.370     | 0.410 | 9.40        | 10.41 |
| b   | 0.020 | 0.035  | 0.508 | 0.89        | L   | 0.055     | 0.070 | 1.40        | 1.78  |
| b2  | 0.030 | 0.045  | 0.762 | 1.14        | L1  | 0.108 REF |       | 2.74 REF    |       |
| b3  | 0.205 | 0.215  | 5.21  | 5.46        | L2  | 0.020 BSC |       | 0.508 BSC   |       |
| с   | 0.018 | 0.024  | 0.457 | 0.61        | L3  | 0.035     | 0.065 | 0.89        | 1.65  |
| c2  | 0.018 | 0.023  | 0.457 | 0.584       | L4  | 0.025     | 0.040 | 0.635       | 1.016 |
| D   | 0.213 | 0.245  | 5.41  | 6.22        | L5  | 0.045     | 0.060 | 1.14        | 1.52  |
| D1  | 0.205 | -      | 5.21  | -           | θ1° | 0°        | 10°   | 0°          | 10°   |
| Е   | 0.250 | 0.265  | 6.35  | 6.73        | θ°  | 0°        | 15°   | 0°          | 15°   |
| E1  | 0.170 | -      | 4.32  | -           | -   | -         | -     | -           | -     |



## Suggested Pad Layout



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